TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

SSM3J120TU

O Power Management Switch Applications

High-Current Switching Applications

• 1.5 V drive

· Low on-resistance

 $R_{on} = 140 \text{ m}\Omega \text{ (max) (@V_{GS} = -1.5 V)}$

 $R_{on} = 78 \text{ m}\Omega \text{ (max) (@V_{GS} = -1.8 V)}$

 $R_{on} = 49 \text{ m}\Omega \text{ (max) (@V_{GS} = -2.5 V)}$

 $R_{on} = 38 \text{ m}\Omega \text{ (max) } (@V_{GS} = -4.0 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V_{DS}	-20	V	
Gate-Source voltage		V_{GSS}	± 8	٧	
Drain current	DC	I _D	-4.0	Α	
	Pulse	I _{DP}	-8.0	^	
Drain power dissipation		P _D (Note 1)	800	mW	
		P _D (Note 2)	500		
Channel temperature		T _{ch}	150	°C	
Storage temperature	•	T _{stg}	−55~150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the

Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on ceramic board

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 0.8 \text{ t}, \text{ Cu Pad: } 645 \text{ mm}^2)$

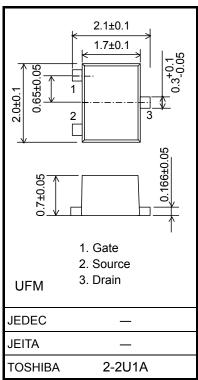
Note 2: Mounted on FR4 board

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}, \text{ Cu Pad: } 645 \text{ mm}^2)$

Electrical Characteristics (Ta = 25°C)

Charac	teristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Drain-Source breakdown voltage	V _{(BR) DSS}	$I_D = -1 \text{ mA}, V_{GS} = 0$		-20	_	_	V	
	V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = +8 \text{ V}$		-12	_	_	V	
Drain cut-off curre	nt	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0$		_	_	-10	μΑ
Gate leakage curre	ent	I _{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0$		_	_	±1	μА
Gate threshold vol	tage	V _{th}	$V_{DS} = -3 \text{ V}, I_{D} = -1 \text{ mA}$		-0.3	_	-1.0	V
Forward transfer a	dmittance	Y _{fs}	$V_{DS} = -3 \text{ V}, I_{D} = -2.0 \text{ A}$	(Note 3)	6.1	12.1	_	S
Drain-Source ON-resistance	R _{DS} (ON)	$I_D = -3.0 \text{ A}, V_{GS} = -4.0 \text{ V}$	(Note 3)	_	28	38	mΩ	
		I _D = -2.0 A, V _{GS} = -2.5 V	(Note 3)	_	34	49		
		$I_D = -1.0 \text{ A}, V_{GS} = -1.8 \text{ V}$	(Note 3)	_	47	78		
		I _D = -0.3 A, V _{GS} = -1.5 V	(Note 3)	_	60	140		
Input capacitance		C _{iss}	V 40.V.V 0		_	1484	_	pF
Output capacitance Reverse transfer capacitance		Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0$ f = 1 MHz		_	185	_	pF
		C _{rss}			_	169	_	pF
Switching time	Turn-on time	t _{on}	$V_{DD} = -10 \text{ V}, I_D = -2.0 \text{ A}$ $V_{GS} = 0 \sim -2.5 \text{ V}, R_G = 4.7 \Omega$		_	67	_	
	Turn-off time	t _{off}		Ω	_	92	_	ns

Unit: mm



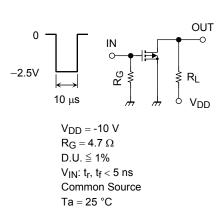
Weight: 6.6mg (typ.)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge	Q_g	$V_{DS} = -16 \text{ V}, I_{DS} = -4.0 \text{ A},$ $V_{GS} = -4.0 \text{ V},$	_	22.3	_	nC
Gate-Source charge	Q _{gs}		_	14.9	_	
Gate-Drain charge	Q _{gd}		_	7.3	_	
Drain-Source forward voltage	V _{DSF}	$I_D = 4.0 \text{ A}, V_{GS} = 0$ (Note 3)	_	0.8	1.2	٧

Note 3: Pulse test

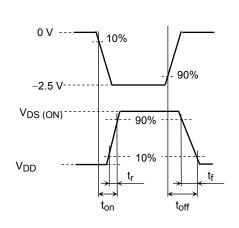
Switching Time Test Circuit





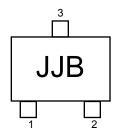
(b) V_{IN}

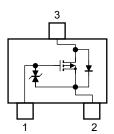
(c) V_{OUT}



Marking

Equivalent Circuit (top view)





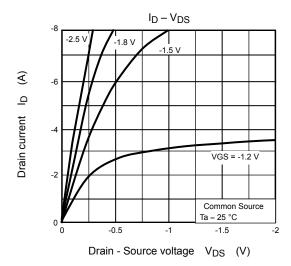
Precaution

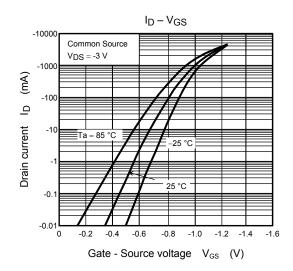
 V_{th} can be expressed as the voltage between the gate and source when the low operating current value is I_D = -1mA for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} . (The relationship can be established as follows: V_{GS} (off) < V_{th} < V_{GS} (on).)

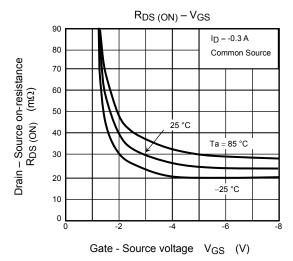
Be sure to take this into consideration when using the device.

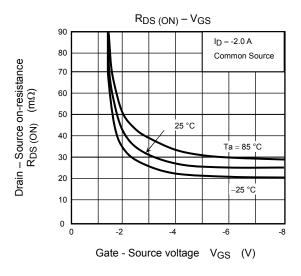
Handling Precaution

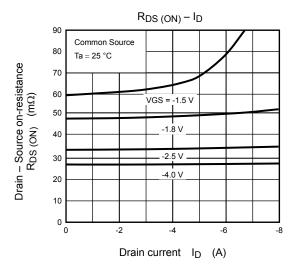
When handling individual devices (which are not yet mounted on a circuit board), ensure that the environment is protected against static electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

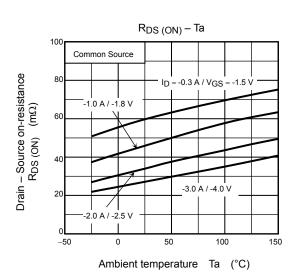


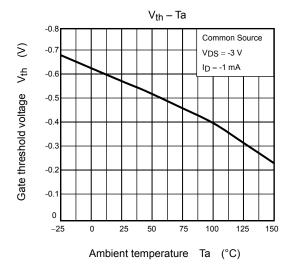


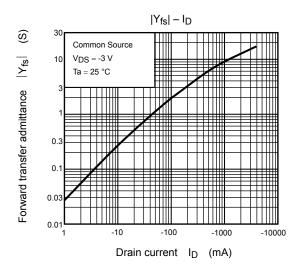


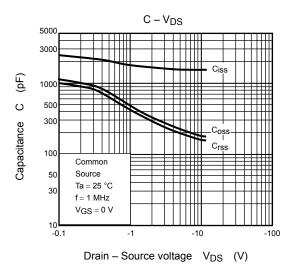


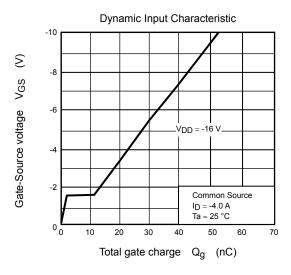


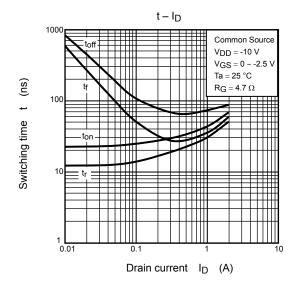


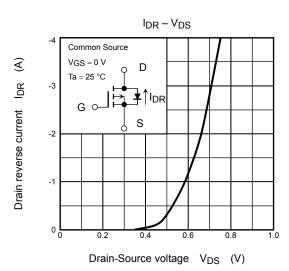


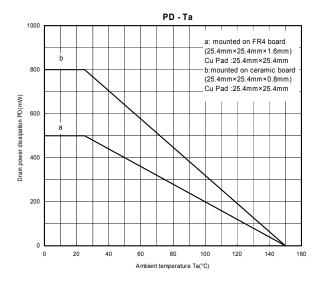


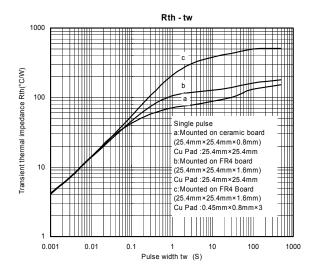












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20070701-EN GENERAL

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